

LS3250SB NPN TRANSISTOR



Linear Systems NPN Transistor

The LS3250SB is a NPN transistor mounted in a single TO-92 package.

The 3 Pin TO-92 provides ease of manufacturing, and the symmetrical pinout prevents improper orientation.

(See Packaging Information).

Low Output Capacitance

FEATURES						
LOW CAPACITANCE	≤ 2pF					
ABSOLUTE MAXIMUM RATINGS ¹						
@ 25°C (unless otherwise noted)						
Maximum Temperatures						
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Storage Temperature	-65°C to +150°C					
Operating Junction Temperature	-55°C to +150°C					
Maximum Power Dissipation						
Continuous Power Dissipation	TBD					
Maximum Currents						
Collector Current	50mA					
Maximum Voltages						
Collector to Collector Voltage	80V					

ELECTRICAL CHARACTERISTICS @ 25°C (unless otherwise noted)

SYMBOL	CHARACTERISTICS	MIN.	TYP.	MAX.	UNITS	CONDITIONS
BV_{CBO}	Collector to Base Voltage	40			٧	I _C = 10mA, I _E = 0
BV_{CEO}	Collector to Emitter Voltage	40			٧	$I_{C} = 10 \mu A, I_{B} = 0$
BV _{EBO} ²	Emitter-Base Breakdown Voltage	6.2			٧	$I_{E} = 10 \mu A, I_{C} = 0$
		100				$I_C = 10 \mu A, V_{CE} = 5 V$
h _{FE}	DC Current Gain	80				$I_C = 100 \mu A, V_{CE} = 5 V$
		80				$I_{C} = 1 \text{mA}, V_{CE} = 5 \text{V}$
V _{CE} (SAT)	Collector Saturation Voltage			0.25	V	$I_{C} = 100 \text{mA}, I_{B} = 10 \text{mA}$
I _{EBO}	Emitter Cutoff Current	-	-	0.2	nA	$I_{C} = 0A, V_{CB} = 3V$
I _{CBO}	Collector Cutoff Current	1	-	0.2	nA	$I_{E} = 0A, V_{CB} = 20V$
C _{OBO}	Output Capacitance	-	-	2	pF	$I_{E} = 0A, V_{CB} = 10V$
f_T	Current Gain Bandwidth Product	-	-	600	MHz	$I_C = 1 \text{mA}, V_{CE} = 5 \text{V}$
NF	Narrow Band Noise Figure			3	dB	$I_C = 100 \mu A$, $V_{CE} = 5V$, $BW = 200 Hz$, $R_B = 10 \Omega$,
						f = 1KHz

Notes

- 1. Absolute Maximum ratings are limiting values above which serviceability may be impaired
- 2. The reverse base-to-emitter voltage must never exceed 6.2 volts; the reverse base-to-emitter current must never exceed 10µA.



T0-92 (Bottom View)

Available Packages:

LS3250SB in TO-92 LS3250SB available as bare die

Please contact Micross for full package and die dimensions:

Email: chipcomponents@micross.com
Web: www.micross.com/distribution.aspx

